

**REMARKS**

At the outset, the Examiner is thanked for the thorough review and consideration of the pending application. The Office Action dated December 27, 2005, has been received and its contents carefully reviewed.

Applicants thank the Examiner for indicating that claims 4-6 recite allowable subject matter.

In the Office Action, claims 1 and 2 are rejected under 35 U.S.C. § 103(a) as being unpatentable over U.S. Patent No. 6,380,559B1 to Park et al. (hereinafter "Park"). Claim 3 is rejected under 35 U.S.C. § 103(a) as being unpatentable over Park as applied to claim 1 above and further in view of U.S. Patent No. 6,255,130B1 to Kim (hereinafter "Kim"). Applicant amends claim 1 to more clearly recite the features of the invention that were believed inherent in the original claims.

The rejection of claims 1-3 is respectfully traversed and reconsideration is requested. Claims 1-6 are allowable over the cited references in that each of these claims recites a combination of elements including, for example, "forming a data pad protection electrode and forming a pixel electrode in a third masking process; arranging a cutting-off plate on a remainder region of the substrate other than the region of the pad part; and exposing the gate pad of the pad part and the data pad protection electrode by a etching process using the cutting-off plate" as recited in claim 1. None of the cited references including Park and Kim singly or in combination, teaches or suggests at least this feature of the claimed invention. The method of claim 1 of the present invention is different from the Park and Kim methods in that neither reference discloses the masking and fabrication processes including "forming a data pad protection electrode and forming a pixel electrode in a third masking process arranging a cutting-off plate...and exposing...using the cutting-off plate" as recited in claim 1. Accordingly,

Applicant respectfully submits that claim 1 and claims 2-3, which depend from claim 1, are allowable over the cited references.

Applicants believe the foregoing amendments place the application in condition for allowance and early, favorable action is respectfully solicited.

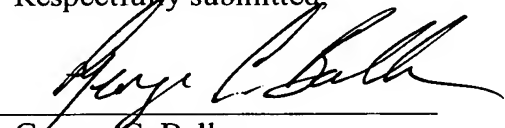
If for any reason the Examiner finds the application other than in condition for allowance, the Examiner is requested to call the undersigned attorney at (202) 496-7500 to discuss the steps necessary for placing the application in condition for allowance. All correspondence should continue to be sent to the below-listed address.

If these papers are not considered timely filed by the Patent and Trademark Office, then a petition is hereby made under 37 C.F.R. § 1.136, and any additional fees required under 37 C.F.R. § 1.136 for any necessary extension of time, or any other fees required to complete the filing of this response, may be charged to Deposit Account No. 50-0911. Please credit any overpayment to deposit Account No. 50-0911. *A duplicate copy of this sheet is enclosed.*

Respectfully submitted,

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By



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